SOT23 SILICON HIGH CURRENT SCHOTTKY BARRIER DIODE "SuperBAT"

ZHCS756

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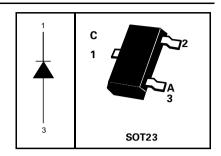
FEATURES:

- Low V_F
- High Current Capability

APPLICATIONS:

- DC DC converters
- Mobile telecomms
- PCMCIA

PARTMARK DETAIL: S76



ABSOLUTE MAXIMUM RATINGS.

PARAMETER	SYMBOL	VALUE	UNIT
Continuous Reverse Voltage	V _R	60	V
Forward Current (Continuous)	I _F	750	mA
Forward Voltage @ I _F = 750mA	V _F	610	mV
Average Peak Forward Current; D.C. = 50%	I _{FAV}	1500	mA
Non Repetitive Forward Current t≤100μs t≤10ms	I _{FSM}	12 5	A A
Power Dissipation at T _{amb} = 25° C	P _{tot}	500	mW
Storage Temperature Range	T _{stg}	-55 to + 150	°C
Junction Temperature	T _j	125	°C

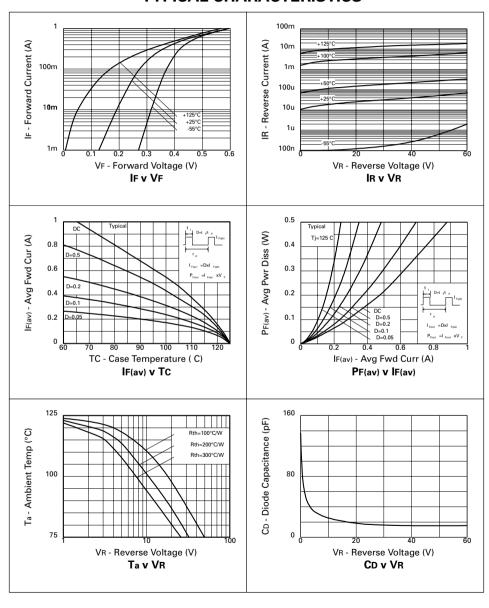
ELECTRICAL CHARACTERISTICS (at T_{amb} = 25° C unless otherwise stated).

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS.
Reverse Breakdown Voltage	V _{(BR)R}	60	80		V	I _R = 300μA
Forward Voltage	V _F		250 285 350 440 520 600 760	290 330 410 500 610 700 900	mV mV mV mV mV mV	I _F = 50mA* I _F = 100mA* I _F = 250mA* I _F = 500mA* I _F = 750mA* I _F = 1000mA* I _F = 1500mA*
Reverse Current	I _R		50	100	μА	V _R = 45V
Diode Capacitance	C _D		17		pF	f= 1MHz,V _R = 25V
Reverse Recovery Time	t _{rr}		12		ns	switched from $I_F = 500 \text{mA}$ to $I_R = 500 \text{mA}$ Measured at $I_R = 50 \text{mA}$

^{*}Measured under pulsed conditions. Pulse width= 300µs; duty cycle ≤2%.

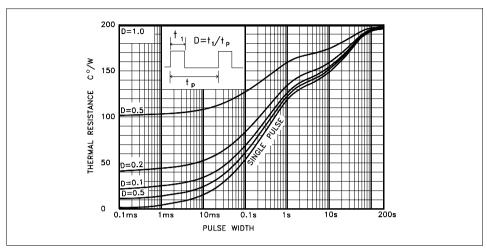
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TYPICAL CHARACTERISTICS



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TYPICAL CHARACTERISTICS



MAXIMUM TRANSIENT THERMAL RESISTANCE

* Reference above figure, devices were mounted on a 15mmx15mm ceramic substrate.